

SMD Comm X7R FO, Ceramic, 0.22 uF, 20%, 25 VDC, X7R, SMD, MLCC, Open Mode, Temperature Stable, 0805



Dimensions		
Chip Size	0805	
L	2mm +/-0.2mm	
W	1.25mm +/-0.2mm	
Т	0.9mm +/-0.10mm	
S	0.75mm MIN	
В	0.5mm +/-0.25mm	

Packaging Specifications		
Packaging:	T&R, 330mm, Paper Tape	
Packaging Quantity:	15000	

General Information	
Series:	SMD Comm X7R FO
Style:	SMD Chip
Description:	SMD, MLCC, Open Mode, Temperature Stable
Features:	Open Mode, Temperature Stable
RoHS:	Yes
Termination:	Tin
Marking:	No
AEC-Q200:	No
Component Weight:	13 mg
Shelf Life:	78 Weeks
MSL:	1

Specifications	
Capacitance:	0.22 uF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	20%
Voltage DC:	25 VDC
Dielectric Withstanding Voltage:	62.5 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	15%, 1kHz 1.0Vrms
Dissipation Factor:	3.5% 1 kHz 1.0Vrms
Aging Rate:	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance:	2.2727 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.



单击下面可查看定价,库存,交付和生命周期等信息

>>KEMET(基美)